

MOSFET

OptiMOS[™] 6 Power-Transistor, 120 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating
- 175°C operating temperature

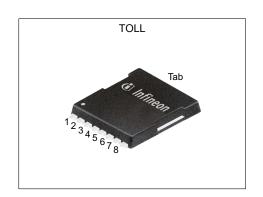
- Optimized for high frequency switching
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020

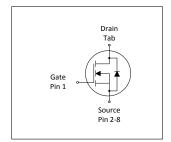


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
$V_{ extsf{DS}}$	120	V
R _{DS(on),max}	1.7	mΩ
I _D	331	A
Qoss	266	nC
Q _G	113	nC
Q _{rr} (1000 A/μs)	301	nC











Type / Ordering Code	Package	Marking	Related Links
IPT017N12NM6	PG-HSOF-8	017N12N6	-

OptiMOS[™] 6 Power-Transistor, 120 V



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OptiMOS[™] 6 Power-Transistor, 120 V **IPT017N12NM6**



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Damamastan	Ob. a.l	Values				N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - - -	- - -	331 234 212 29	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =8 V, T_{C} =100 °C V_{GS} =10 V, T_{A} =25 °C, R_{THJA} =50 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1324	Α	<i>T</i> _A =25 °C
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	150	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse	E AS	-	-	1328	mJ	$I_{\rm D}$ =77 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	395 3.0	W	T _C =25 °C T _A =25 °C, R _{THJA} =50 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			l lmi4	Note / Test Condition
raiailletei	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.38	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information.

4) See Diagram 13 for more detailed information.

OptiMOS[™] 6 Power-Transistor, 120 V IPT017N12NM6



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Danamatan	Corrects of		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	120	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	2.6	3.1	3.6	V	V _{DS} =V _{GS} , I _D =275 μA	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	1.46 1.65	1.7 2.06	mΩ	V _{GS} =10 V, I _D =150 A V _{GS} =8 V, I _D =75 A	
Gate resistance	R _G	0.55	1.1	1.65	Ω	-	
Transconductance	g fs	125	250	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 150 A$	

Table 5 Dynamic characteristics

Davamatav	Cymahal	Values			11	Nata / Taat Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	8100	11000	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	2400	3100	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	40	70	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	19	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	17	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	34	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	19	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Devementar	Symbol	Values			11:4	Nata / Task Canditian
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge ¹⁾	Q _{gs}	-	41	53	nC	V_{DD} =60 V, I_{D} =75 A, V_{GS} =0 to 10 V
Gate charge at threshold ¹⁾	Q _{g(th)}	-	25	31	nC	V _{DD} =60 V, I _D =75 A, V _{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	25	38	nC	V _{DD} =60 V, I _D =75 A, V _{GS} =0 to 10 V
Switching charge	Q _{sw}	-	40	-	nC	V _{DD} =60 V, I _D =75 A, V _{GS} =0 to 10 V
Gate charge total ¹⁾	Qg	-	113	141	nC	V_{DD} =60 V, I_{D} =75 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.0	-	V	V_{DD} =60 V, I_{D} =75 A, V_{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	266	333	nC	V _{DS} =60 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

OptiMOSTM 6 Power-Transistor, 120 V

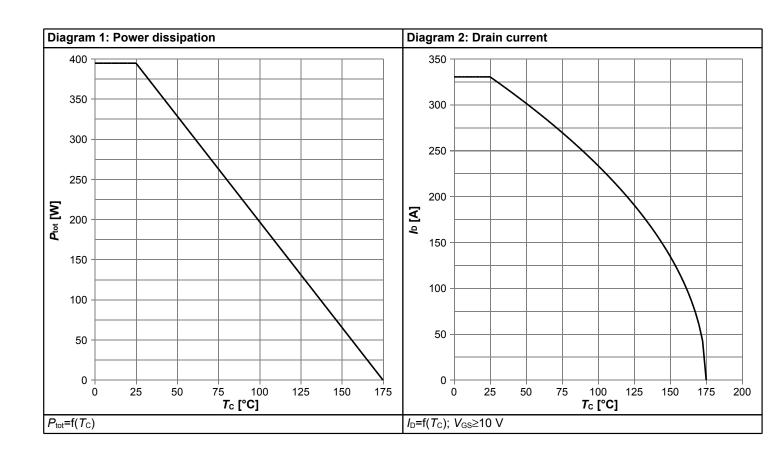


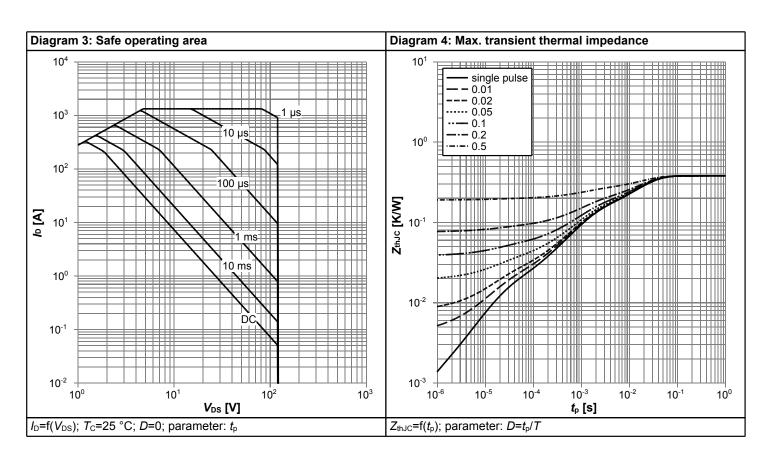
Table 7 Reverse diode

Damamatan	Comple ed		Values			Nata (Table Operation
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	331	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1324	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.87	1.0	V	V _{GS} =0 V, I _F =150 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	40	80	ns	V _R =60 V, I _F =75 A, di _F /dt=300 A/μs
Reverse recovery charge ¹⁾	Qrr	-	111	222	nC	V _R =60 V, I _F =75 A, di _F /dt=300 A/μs
Reverse recovery time ¹⁾	t _{rr}	-	35	70	ns	V_R =60 V, I_F =75 A, di_F/dt =1000 A/ μ s
Reverse recovery charge ¹⁾	Qrr	-	301	602	nC	V_R =60 V, I_F =75 A, di_F/dt =1000 A/ μ s

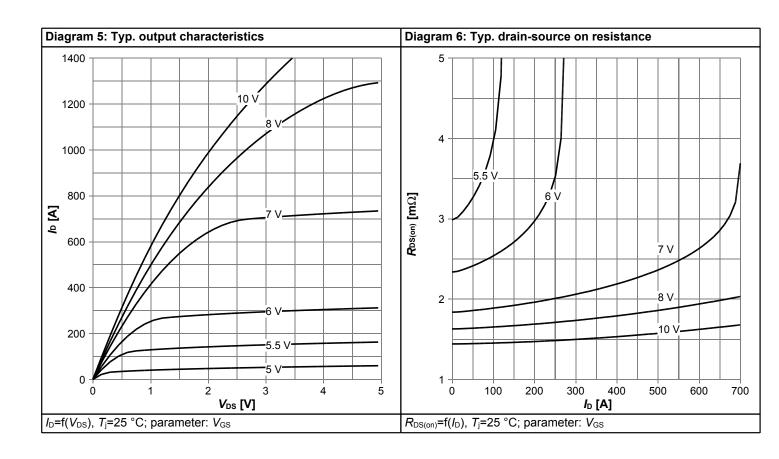


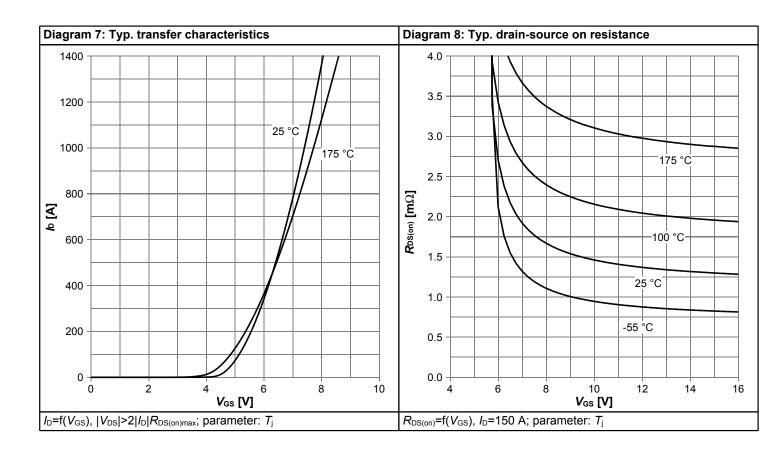
4 Electrical characteristics diagrams



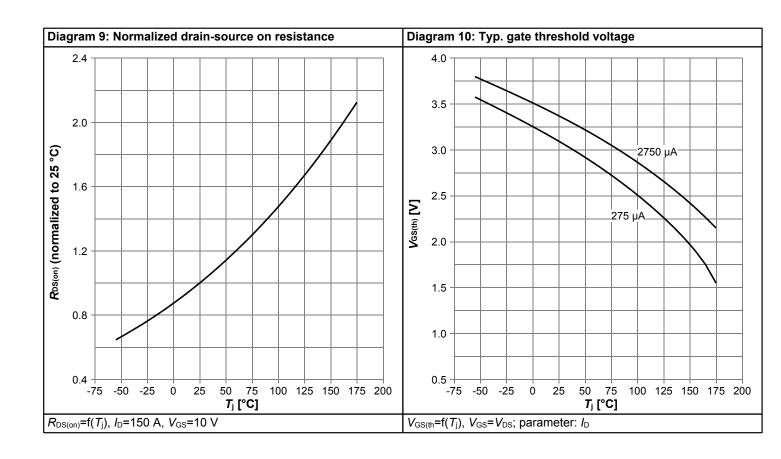


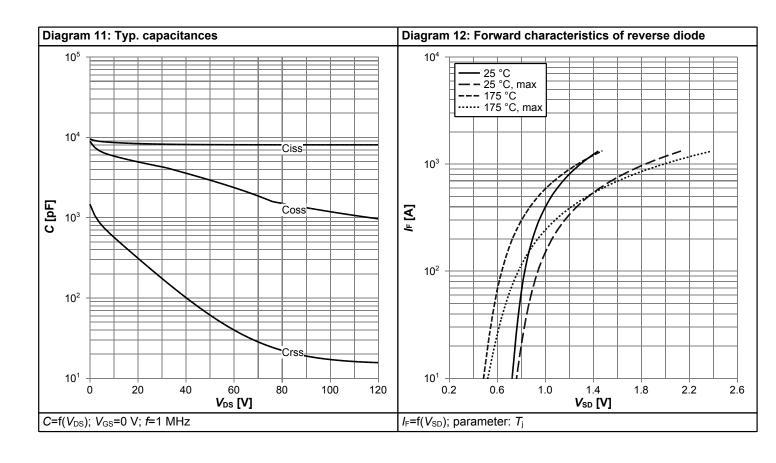




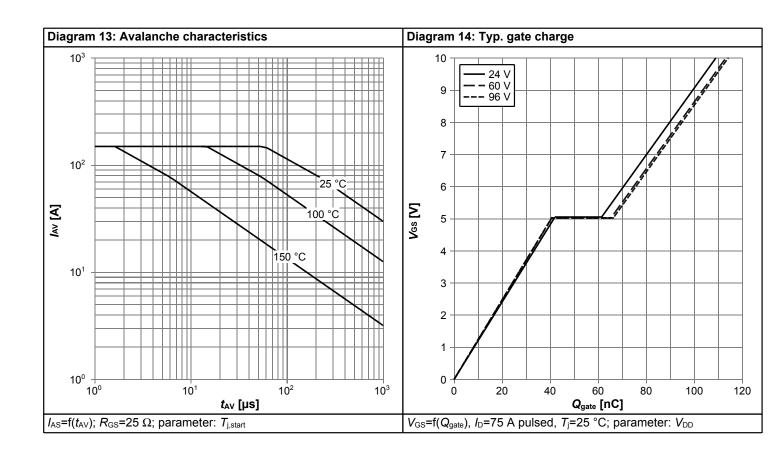


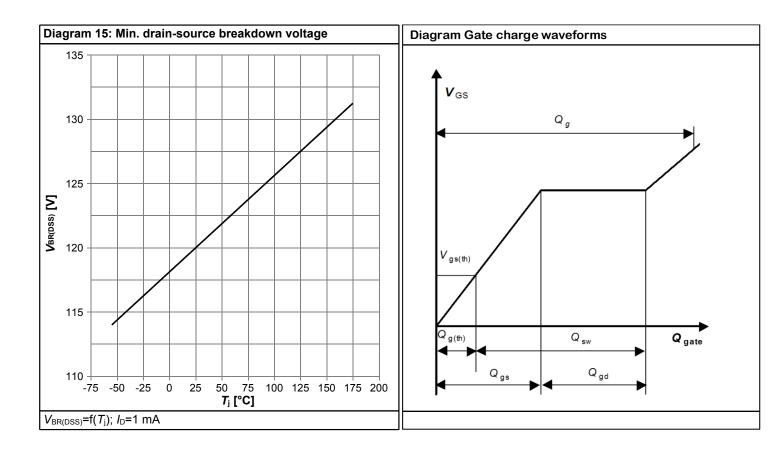














5 Package Outlines

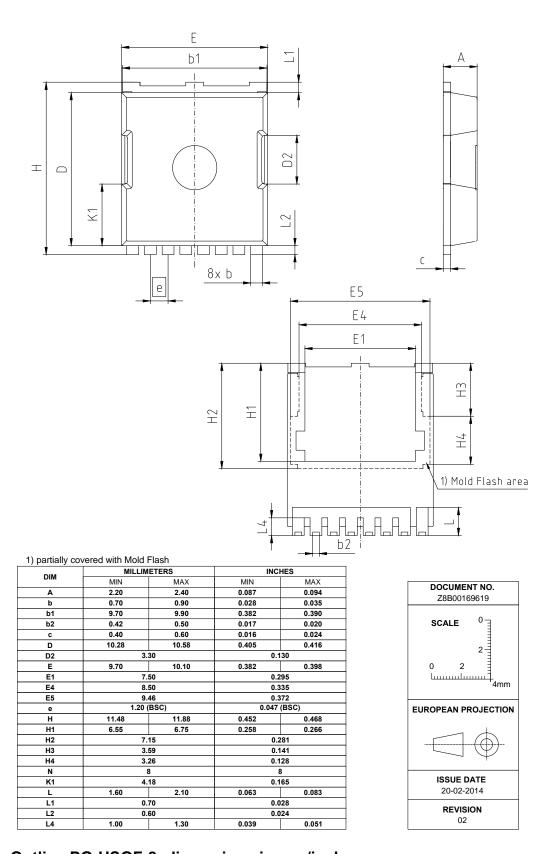


Figure 1 Outline PG-HSOF-8, dimensions in mm/inches

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Revision History

IPT017N12NM6

Revision: 2022-12-06, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)					
2.0	2022-12-06	Release of final version					

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